

Load switch

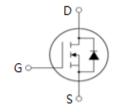
Power management

Wuxi Unigroup Microelectronics CO.,LTD.

20V N-Channel Trench MOSFET

Features Product Summary Trench Power Technology VDS 20V ● Low R_{DS(ON)} $R_{DS(ON)}$ (at V_{GS} =10V) < 18mΩ Low Gate Charge $R_{DS(ON)}$ (at V_{GS} =4.5V) $< 20 m\Omega$ High power and current handing capability • Lead free product is acquired $R_{DS(ON)}$ (at V_{GS} =2.5V) $< 25 m\Omega$ **Applications** I_D (at V_{GS} =10V) 5A Battery protection RoHS





Device	Package	Marking
TTX2312A	SOT-23	2312A

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Parameter		Symbol	Value	Unit	
Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	20	V	
Continuous Drain Current B	$T_{\rm C} = 25^{\rm o}{\rm C}$		5	А	
	$T_{\rm C} = 70^{\rm o}{\rm C}$	l _D	4		
Pulsed Drain Current A		I _{DM}	15	Α	
Gate-Source Voltage		V_{GSS}	±12	V	
Single Pulse Avalanche Energy L =0.3mH ^A		E _{AS}	15	mJ	
Avalanche Current A		I _{As}	10	Α	
Power Dissination C	$T_{\rm C} = 25^{\rm o}{\rm C}$	D	1.56	W	
Power Dissipation ^C	T _C = 100°C	P _D	0.62	W	
Operating Junction and Storage Temperature Range		T _J , T _{SGT}	-55~+150	°C	

Thermal Resistance					
Parameter	Symbol	Max	Unit		
Thermal Resistance, Junction-to-Lead	R _{thJL}	80	00/14/		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	125	°C/W		



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Danamatan			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	20			V	
Zero Gate Voltage Drain Current		$V_{DS} = 20V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μА	
	I _{DSS}	$V_{DS} = 20V, V_{GS} = 0V, T_{J} = 70^{\circ}C$			25		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 12V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.5	0.7	0.9	V	
		$V_{GS} = 10V, I_{D} = 4A$		13.6	18	mΩ	
Drain-Source On-Resistance	R _{DS(on)}	$V_{GS} = 4.5V, I_{D} = 4A$		14.9	20	mΩ	
		$V_{GS} = 2.5V, I_{D} = 4A$		18	18 25 mg		
Forward Transconductance	g _{fs}	$V_{DS} = 5V$, $I_{D} = 6A$		25		S	
Dynamic	•		•				
Input Capacitance	C _{iss}	V _{GS} = 0V,		870		pF	
Output Capacitance	C _{oss}	$V_{DS} = 10V$		119			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		110			
Total Cata Charge	Q _g (10V)			22.1		0	
Total Gate Charge	Q _g (4.5V)	$V_{DD} = 10V, I_{D} = 5A,$		11			
Gate-Source Charge	Q _{gs}	$V_{GS} = 10V$		2		nC	
Gate-Drain Charge	Q_{gd}			2			
Turn-on Delay Time	t _{d(on)}			4			
Turn-on Rise Time	t _r	$V_{DD} = 10V, V_{DD} = 10V,$		8.2		ns	
Turn-off Delay Time	t _{d(off)}	$I_D = 3A, R_G = 2.5\Omega$		22			
Turn-off Fall Time	t _f			7			
Drain-Source Body Diode Characte	ristics		•	-			
Continuous Body Diode Current B	Is	T 0500			5	•	
Pulsed Diode Forward Current	I _{SM}	$T_{\rm C} = 25^{\rm o}{\rm C}$			20	A	
Body Diode Voltage	V_{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 5\text{A}, V_{GS} = 0\text{V}$			1.2	V	

- A. Single pulse width limited by maximum junction temperature.
- B. The maximum current rating is package limited.
- C. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



I_D, Drain Current (A)

R_{DS(on)}, On-Resistance (mΩ)

V_{GS}, Gate-to-Source Voltage (V)

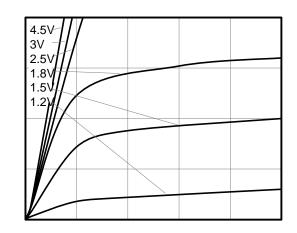
Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

I_D, Drain Current (A)

Capacitance (pF)

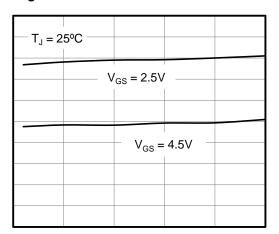
Is, Source Current (A)

Figure 1. Output Characteristics

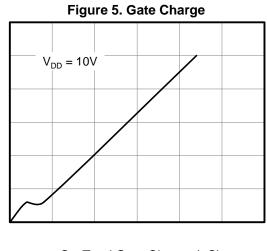


V_{DS}, Drain-to-Source Voltage (V)

Figure 3. On-Resistance vs. Drain Current



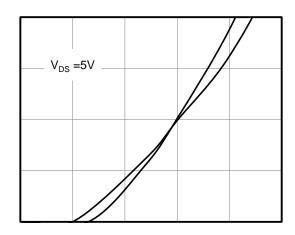
I_D, Drain Current (A)



Q_q, Total Gate Charge (nC)

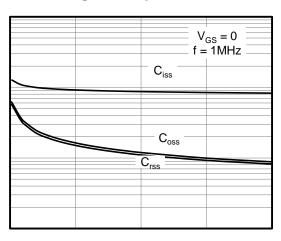
Figure 2. Transfer Characteristics

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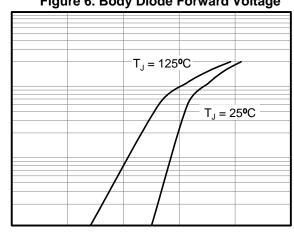
V_{GS}, Gate-to-Source Voltage (V)

Figure 4. Capacitance



V_{DS}, Drain-to-Source Voltage (V)

Figure 6. Body Diode Forward Voltage



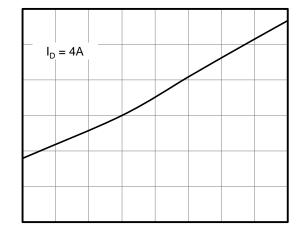
V_{SD}, Source-to-Drain Voltage (V)



R_{DS(on)}, (Normalized)

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

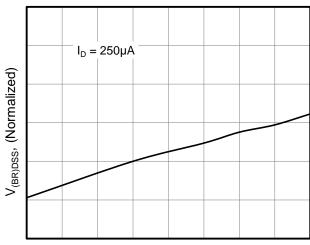
Figure 7. On-Resistance vs. Junction Temperature



T_J, Junction Temperature (°C)

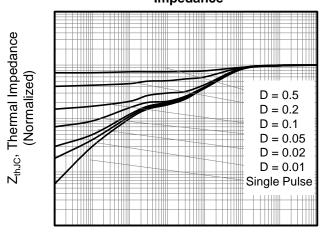
Figure 9. V(BR)DSS vs.

Junction Temperature



T_J, Junction Temperature (°C)

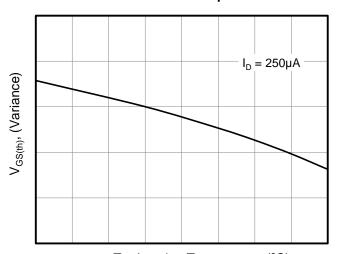
Figure 11. Transient Thermal Impedance



T_p, Pulse Width (S)

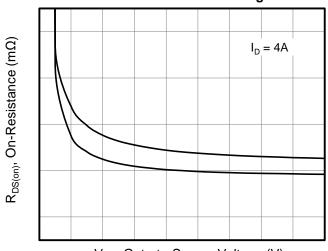
Figure 8. Threshold Voltage vs. Junction Temperature

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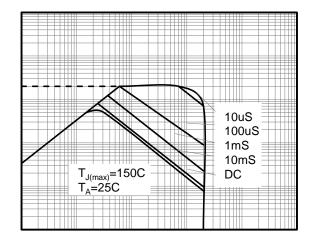
T_J, Junction Temperature (°C)

Figure 10. On-Resistance vs. Gate-to-Source Voltage



V_{GS}, Gate-to-Source Voltage (V)

Figure 12. Safe operation area



V_{DS}, Drain-to-Source Voltage (V)

ID, Drain Current(A)

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Figure A: Gate Charge Test Circuit and Waveform

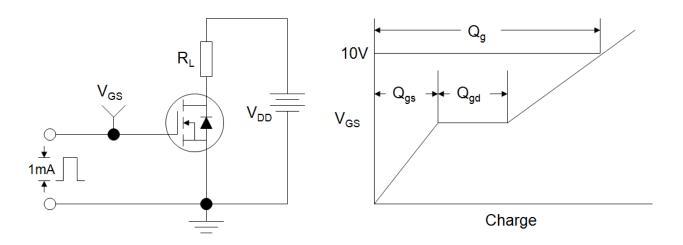


Figure B: Resistive Switching Test Circuit and Waveform

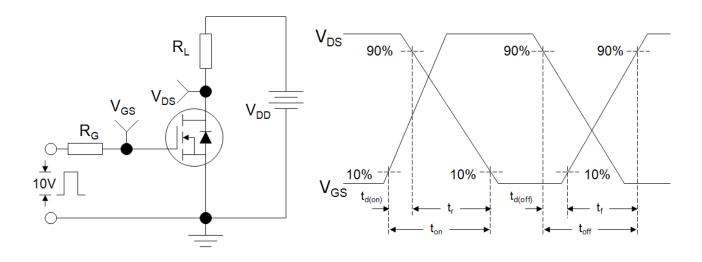
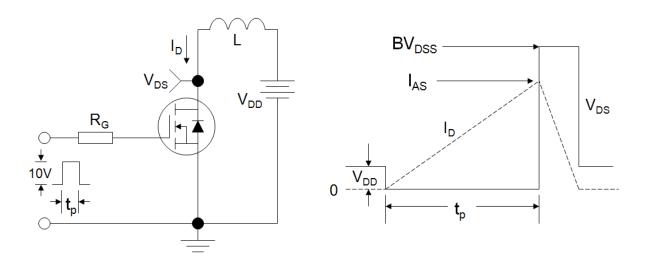
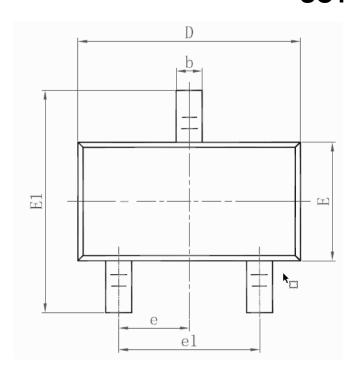


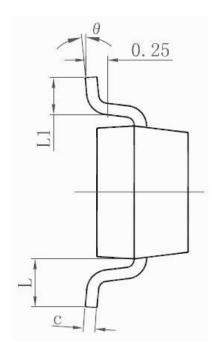
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

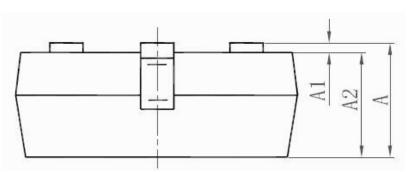




SOT-23







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
e	0.950	0.037 TYP.		TYP.	
e1	1.800	2.000	0.071	0.079	
L	0.550 REF.		0.022 REF.		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	



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